

SN54AHC74, SN74AHC74 DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH CLEAR AND PRESET

SCLS255E – DECEMBER 1995 – REVISED NOVEMBER 1998

- Operating Range 2-V to 5.5-V V_{CC}
- EPIC™ (Enhanced-Performance Implanted CMOS) Process
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs

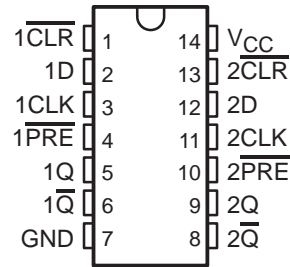
description

The 'AHC74 devices are dual positive-edge-triggered D-type flip-flops.

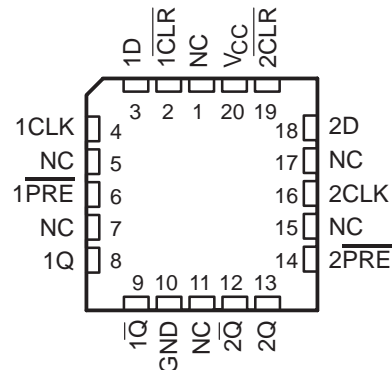
A low level at the preset (\overline{PRE}) or clear (\overline{CLR}) inputs sets or resets the outputs, regardless of the levels of the other inputs. When \overline{PRE} and \overline{CLR} are inactive (high), data at the data (D) input meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the levels at the outputs.

The SN54AHC74 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AHC74 is characterized for operation from -40°C to 85°C .

SN54AHC74 . . . J OR W PACKAGE
SN74AHC74 . . . D, DB, DGV, N, OR PW PACKAGE
(TOP VIEW)



SN54AHC74 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

FUNCTION TABLE

INPUTS				OUTPUTS	
\overline{PRE}	\overline{CLR}	CLK	D	Q	\overline{Q}
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H [†]	H [†]
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	L	X	Q ₀	\overline{Q}_0

[†] This configuration is nonstable; that is, it does not persist when \overline{PRE} or \overline{CLR} returns to its inactive (high) level.



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**TEXAS
INSTRUMENTS**

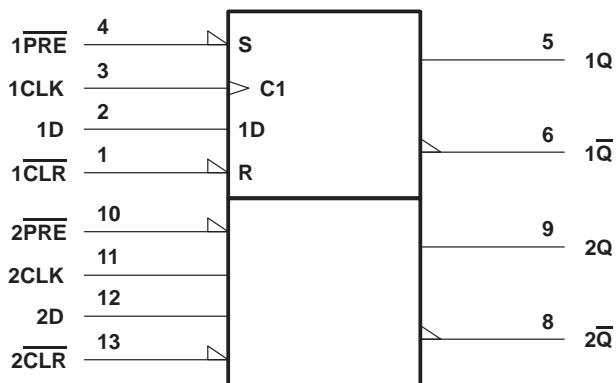
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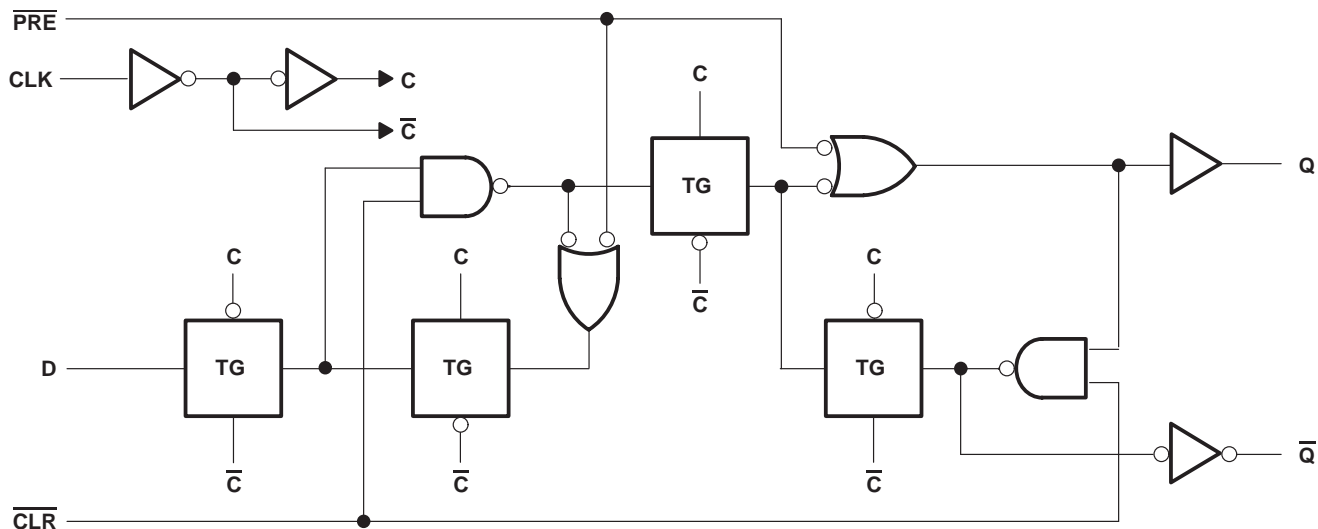
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, DGV, J, N, PW, and W packages.

logic diagram, each flip-flop (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7 V
Output voltage range, V_O (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2): D package	127°C/W
DB package	158°C/W
DGV package	182°C/W
N package	78°C/W
PW package	170°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions (see Note 3)

		SN54AHC74		SN74AHC74		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	2	5.5	2	5.5	V
V_{IH}	High-level input voltage	$V_{CC} = 2$ V		1.5		V
		$V_{CC} = 3$ V		2.1		
		$V_{CC} = 5.5$ V		3.85		
V_{IL}	Low-level input voltage	$V_{CC} = 2$ V		0.5		V
		$V_{CC} = 3$ V		0.9		
		$V_{CC} = 5.5$ V		1.65		
V_I	Input voltage	0	5.5	0	5.5	V
V_O	Output voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 2$ V		–50		μ A
		$V_{CC} = 3.3$ V \pm 0.3 V		–4		mA
		$V_{CC} = 5$ V \pm 0.5 V		–8		
I_{OL}	Low-level output current	$V_{CC} = 2$ V		50		μ A
		$V_{CC} = 3.3$ V \pm 0.3 V		4		mA
		$V_{CC} = 5$ V \pm 0.5 V		8		
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 3.3$ V \pm 0.3 V		100		ns/V
		$V_{CC} = 5$ V \pm 0.5 V		20		
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54AHC74		SN74AHC74		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OH}	I _{OH} = -50 μA	2 V	1.9	2		1.9		1.9	V	
		3 V	2.9	3		2.9		2.9		
		4.5 V	4.4	4.5		4.4		4.4		
	I _{OH} = -4 mA	3 V	2.58			2.48		2.48		
	I _{OH} = -8 mA	4.5 V	3.94			3.8		3.8		
V _{OL}	I _{OL} = 50 μA	2 V			0.1		0.1	0.1	V	
		3 V			0.1		0.1	0.1		
		4.5 V			0.1		0.1	0.1		
	I _{OL} = 4 mA	3 V			0.36		0.5	0.44		
	I _{OL} = 8 mA	4.5 V			0.36		0.5	0.44		
I _I	Data inputs	V _I = V _{CC} or GND	5.5 V			±0.1		±1	±1	μA
	Control inputs					±0.1		±1	±1	
I _{CC}	V _I = V _{CC} or GND, I _O = 0		5.5 V			2		20	20	μA
C _i	V _I = V _{CC} or GND		5 V		2	10			10	pF

timing requirements over recommended operating free-air temperature range,
V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

			T _A = 25°C		SN54AHC74		SN74AHC74		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t _w	Pulse duration	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ low	6		7		7		ns
		CLK	6		7		7		
t _{su}	Setup time before CLK↑	Data	6		7		7		ns
		$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ inactive	5		5		5		
t _h	Hold time, data after CLK↑		0.5		0.5		0.5		ns

timing requirements over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

			T _A = 25°C		SN54AHC74		SN74AHC74		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t _w	Pulse duration	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ low	5		5		5		ns
		CLK	5		5		5		
t _{su}	Setup time before CLK↑	Data	5		5		5		ns
		$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ inactive	3		3		3		
t _h	Hold time, data after CLK↑		0.5		0.5		0.5		ns



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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	SN54AHC74				UNIT	
				$T_A = 25^\circ\text{C}$			MIN		MAX
				MIN	TYP	MAX			
f_{max}			$C_L = 15\text{ pF}^*$	80	125	70	MHz		
			$C_L = 50\text{ pF}$	50	75	45			
t_{PLH}^*	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}	$C_L = 15\text{ pF}$	7.6	12.3	1	14.5	ns	
t_{PHL}^*				7.6	12.3	1	14.5		
t_{PLH}^*	CLK	Q or \overline{Q}	$C_L = 15\text{ pF}$	6.7	11.9	1	14	ns	
t_{PHL}^*				6.7	11.9	1	14		
t_{PLH}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}	$C_L = 50\text{ pF}$	10.1	15.8	1	18	ns	
t_{PHL}				10.1	15.8	1	18		
t_{PLH}	CLK	Q or \overline{Q}	$C_L = 50\text{ pF}$	9.2	15.4	1	17.5	ns	
t_{PHL}				9.2	15.4	1	17.5		

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	SN74AHC74				UNIT	
				$T_A = 25^\circ\text{C}$			MIN		MAX
				MIN	TYP	MAX			
f_{max}			$C_L = 15\text{ pF}$	80	125	70	MHz		
			$C_L = 50\text{ pF}$	50	75	45			
t_{PLH}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}	$C_L = 15\text{ pF}$	7.6	12.3	1	14.5	ns	
t_{PHL}				7.6	12.3	1	14.5		
t_{PLH}	CLK	Q or \overline{Q}	$C_L = 15\text{ pF}$	6.7	11.9	1	14	ns	
t_{PHL}				6.7	11.9	1	14		
t_{PLH}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}	$C_L = 50\text{ pF}$	10.1	15.8	1	18	ns	
t_{PHL}				10.1	15.8	1	18		
t_{PLH}	CLK	Q or \overline{Q}	$C_L = 50\text{ pF}$	9.2	15.4	1	17.5	ns	
t_{PHL}				9.2	15.4	1	17.5		

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	SN54AHC74				UNIT	
				$T_A = 25^\circ\text{C}$			MIN		MAX
				MIN	TYP	MAX			
f_{max}			$C_L = 15\text{ pF}^*$	130	170	110	MHz		
			$C_L = 50\text{ pF}$	90	115	75			
t_{PLH}^*	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}	$C_L = 15\text{ pF}$	4.8	7.7	1	9	ns	
t_{PHL}^*				4.8	7.7	1	9		
t_{PLH}^*	CLK	Q or \overline{Q}	$C_L = 15\text{ pF}$	4.6	7.3	1	8.5	ns	
t_{PHL}^*				4.6	7.3	1	8.5		
t_{PLH}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}	$C_L = 50\text{ pF}$	6.3	9.7	1	11	ns	
t_{PHL}				6.3	9.7	1	11		
t_{PLH}	CLK	Q or Q	$C_L = 50\text{ pF}$	6.1	9.3	1	10.5	ns	
t_{PHL}				6.1	9.3	1	10.5		

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	SN74AHC74				UNIT	
				$T_A = 25^\circ\text{C}$			MIN		MAX
				MIN	TYP	MAX			
f_{max}			$C_L = 15\text{ pF}$	130	170	110	MHz		
			$C_L = 50\text{ pF}$	90	115	75			
t_{PLH}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}	$C_L = 15\text{ pF}$	4.8	7.7	1	9	ns	
t_{PHL}				4.8	7.7	1	9		
t_{PLH}	CLK	Q or \overline{Q}	$C_L = 15\text{ pF}$	4.6	7.3	1	8.5	ns	
t_{PHL}				4.6	7.3	1	8.5		
t_{PLH}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or \overline{Q}	$C_L = 50\text{ pF}$	6.3	9.7	1	11	ns	
t_{PHL}				6.3	9.7	1	11		
t_{PLH}	CLK	Q or Q	$C_L = 50\text{ pF}$	6.1	9.3	1	10.5	ns	
t_{PHL}				6.1	9.3	1	10.5		

noise characteristics, $V_{CC} = 5\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 4)

PARAMETER		SN74AHC74		UNIT
		MIN	MAX	
$V_{OL(P)}$	Quiet output, maximum dynamic V_{OL}	0.8		V
$V_{OL(V)}$	Quiet output, minimum dynamic V_{OL}	-0.8		V
$V_{OH(V)}$	Quiet output, minimum dynamic V_{OH}	4.7		V
$V_{IH(D)}$	High-level dynamic input voltage	3.5		V
$V_{IL(D)}$	Low-level dynamic input voltage		1.5	V

NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

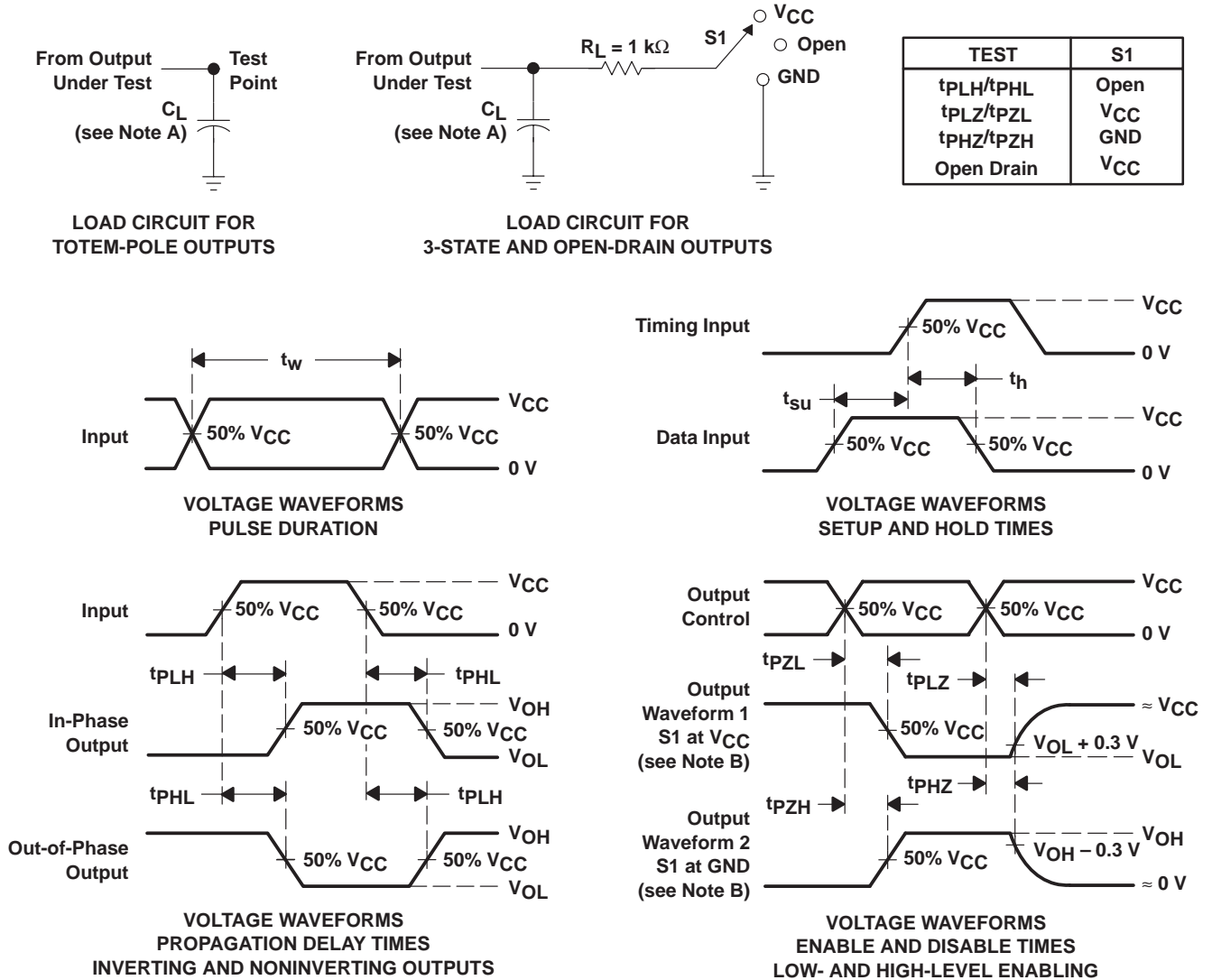
PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance	No load, $f = 1\text{ MHz}$	32 pF



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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is high except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is low except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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